Chinastandards.org

CCS L95

SJ

INDUSTRY STANDARD OF THE PEOPLE'S REPUBLIC OF CHINA

SJ 21247-2018

Micro-assembly electroplating system process verification method

微组装电镀系统工艺验证方法

(English Translation)

Issued by: Ministry of Industry and Information Technology

Preview: page 1 of 3 shown, 8 in the full document. Complete English PDF, instant download:
https://chinastandards.org/standards/sj-21247-2018

Chinastandards.org

Table of Contents

[Preview only]
1 Scope
2 Normative References
2.1 Terms
3 Terms and Definitions
4 Overview
4.1 General requirements
5 Technical Requirements
6 Calibration conditions
6.1 Environmental conditions
6.2 Measurement standards and other equipment
7 Calibration items and calibration methods
7.1 Calibration Items
7.2 Calibration method
8 Expression of calibration results
9 Recalibration interval

1 Foreword

SJ 21247-2018 is issued by Ministry of Industry and Information Technology.

The SJ prefix, without a suffix, marks a mandatory standard: within its scope, compliance is required.

The document runs to 8 pages in English translation.

2 Scope Preview

SJ 21247-2018 is filed under Chinese Standard Classification L95, in the field of electronic components and information technology.

This catalogue holds 1,191 other SJ standards without an ICS number.

In this catalogue, SJ standards carry edition years from 1965 to 2021.

Preview: page 2 of 3 shown, 8 in the full document. Complete English PDF, instant download:
https://chinastandards.org/standards/sj-21247-2018

3 About this standard

Sector: Electronics Industry Standard

Issued by: Ministry of Industry and Information Technology

English translation: about 8 pages (approximate)

Chinese original: about 12,166 characters

4 Related standards

Standards on related subjects:

GB/T 28159-2025 - Electronic grade phosphoric acid

SJ/T 11794-2022 - Test method for unbonded lithium of cathode materials used in lithium ion battery

SJ/T 11795-2022 - Test method for determining magnetic impurity content of electrode materials in lithium ion batteries

SJ 21242-2018 - General specification for wafer bump plating equipment

SJ 21241-2018 - General specification for electroless plating stations

SJ 21240-2018 - General specification for cantilever plating systems

5 Classification and status

Chinese Standard Classification (CCS): L 95

Prefix SJ: mandatory standard.

Preview: page 3 of 3 shown, 8 in the full document. Complete English PDF, instant download:
https://chinastandards.org/standards/sj-21247-2018